

**GENERAL PURPOSE** HIGH ISOLATION VOLTAGE SINGLE TRANSISTOR TYPE PHOTOCOUPLER SERIES

#### **FEATURES**

- 1.AC Input
- 2. High isolation voltage between input and output (Viso=5000 Vrms)
- 3.Compact dual-in-line package

KB814:1-channel type

- 4. Recognized by UL and CUL, file NO. E225308
- 5. Approved by VDE 0884 Teil2(NO:40006364) (Creepage distance between input and output:7mm or more)

#### DESCRIPTION

- 1. The KB814(1-channel) is optically coupled isolators containing two GaAs light emitting diode and an NPN silicon phototransistor.
- 2. The lead pitch is 2.54mm.

## **APPLICATIONS**

- 1.Computer terminals.
- 2. Registers, copiers, automatic vending machines.
- 3. System appliances, measuring instruments.
- 4. Programmable logic controller.
- 5. Signal transmission between circuits of different potentials and impedances.

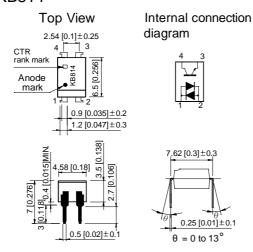
PAGE: 1 OF 8 SPEC NO: DSAD1533 **REV NO: V.3** DATE: JUN/19/2003 CHECKED: Tracy Deng DRAWN: Y.H.LI

APPROVED: J. Lu



# \*PACKAGE DIMENSIONS (UNIT:mm) DIP Type

#### **KB814**



- 1. Anode, Cathode
- 3. Emitter
- 2. Anode, Cathode
- 4. Collector

TOLERANCE :  $\pm 0.5 [\pm 0.02]$  UNLESS OTHERWISE NOTED.

## \* Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	IF	± 50	mA
	Power dissipation	Р	70	mW
	Collector-emitter voltage	V <sub>CEO</sub>	35	V
Output	Emitter-collector voltage	V <sub>ECO</sub>	6	V
Catput	Collector current	IC	50	mA
	Collector power dissipation	PC	150	mW
Total po	wer dissipation	Ptot	200	mW
*1 Isolatio	n voltage	Viso	5000	V <sub>rms</sub>
Operatin	g temperature	Topr	-30~+100	° C
Storage	temperature	Tstg	-55~+125	° C
*2 Soldering temperature		Tsol	260	° C

<sup>\*1 40</sup> to 60%RH, AC for 1 minute

<sup>\*2</sup> For 10 seconds



## \* Electro-optical Characteristics (Ta=25°C)

	Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit
	Forward voltage		VF	I <sub>F</sub> =± 20mA	_	1.2	1.4	V
Input	Peak forward voltage	je	V <sub>FM</sub>	I <sub>FM</sub> =± 0.5A	_	_	3.0	V
Output	Collector dark curre	ent	Iceo	Vce=20V,I <sub>F</sub> =0mA	_	_	10-7	Α
	*1 Current transfer ra	atio	CTR	I <sub>F=±</sub> 1mA, V <sub>CE</sub> =5V	20	_	300	%
Transfer charact-eristics	Collector-emitter saturation voltage		V <sub>CE(</sub> sat)	I <sub>F=±</sub> 20mA, I <sub>C</sub> =1mA	_	0.1	0.2	V
	Response time	t <sub>r</sub>	Vce=2V, Ic=2mA	_	4	18	μS	
		Fall time	t <sub>f</sub>	R <sub>L</sub> =100Ω	_	3	18	μS

\*1 Classification table of current transfer ratio is shown below.

$$CTR = \frac{Ic}{I_F} \times 100\%$$

Model NO.	Rank mark	CTR(%)
KB814L	L	20~60
KB814A	А	50~150
KB814B	В	120~300
KB814LA	L or A	20~150
KB814AB	A or B	50~300
KB814	L,A,B or No mark	20~300



Fig. 1 Current Transfer Ratio vs. Forward Current

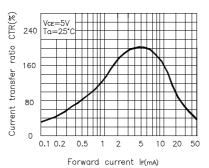


Fig. 3 Collector Current vs.
Collector-emitter Voltage

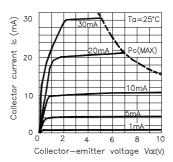


Fig. 5 Collector-emitter Saturation Voltage vs. Ambient Temperature

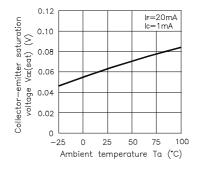


Fig. 2 Forward Current vs. Forward voltage

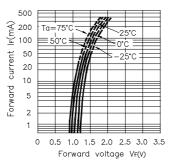


Fig. 4 Relative Current Transfer Ratio vs. Ambient Temperature

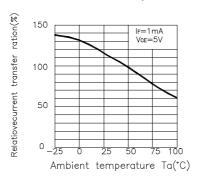


Fig. 6 Collector Dark Current vs.
Ambient Temperature

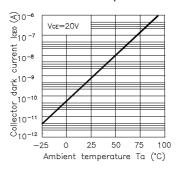




Fig. 7 Forward Current vs.

Ambient Temperature

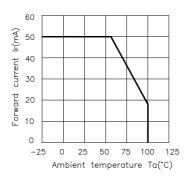


Fig. 8 Collector Power Dissipation vs.
Ambient Temperature

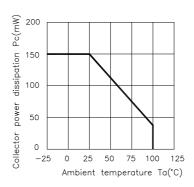
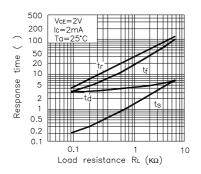


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

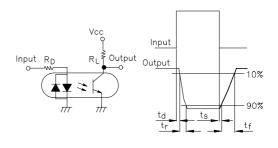
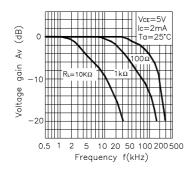
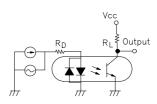


Fig. 10 Frequency Response



Test Circuit for Frequency Response



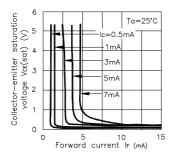
SPEC NO: DSAD1533 REV NO: V.3

APPROVED: J. Lu CHECKED: Tracy Deng

DATE: JUN/19/2003 DRAWN: Y.H.LI PAGE: 5 OF 8



Fig. 11 Collector-emitter Saturation Voltage vs. Forward Current



#### \* NOTES ON HANDLING

1.Recommended soldering conditions (Dip soldering)

#### (1) Dip soldering

Temperature 260 °C or below (molten solder temperature)

Time Less than 10 seconds.

Cycle One cycle allowed to be dipped in solder including plastic nold portion.

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

## (2) Cautions

#### Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## 2. Cautions regarding noise

Be aware that power is suddenly into the component any surge current may cause damage happen, even if the voltage is within the absolute maximum ratings.

PAGE: 6 OF 8 SPEC NO: DSAD1533 **REV NO: V.3** DATE: JUN/19/2003 **CHECKED: Tracy Deng** DRAWN: Y.H.LI

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#### **CAUTION**

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them.

#### RESTRICTIONS ON PRODUCT USE

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices / types available in every country.
- We are mention about our product quality stablity, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing KINGBRIGHT products, to observe standards of safety, and to a avoid situations in which a malfunction or failure of a KINGBRIGHT product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that KINGBRIGHT products are used within specified operating ranges as set forth in the most recent products specifications.

SPEC NO: DSAD1533 **REV NO: V.3** DATE: JUN/19/2003 PAGE: 7 OF 8 DRAWN: Y.H.LI

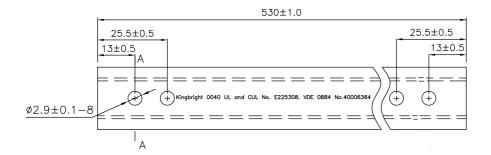
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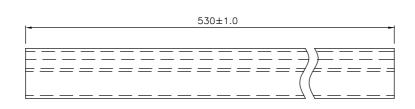


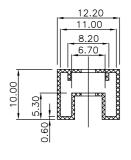
Dimension of Tube

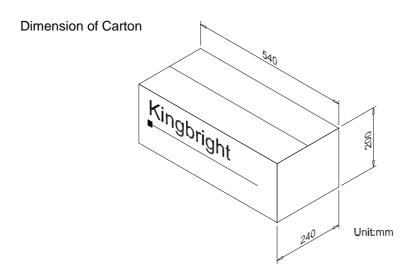
TOLERANCE :  $\pm$  0.4[ $\pm$  0.012] UNLESS OTHERWISE NOTED. Unit:mm



A-A Side view







Part Number	Package	Packing Style
KB814	4-pin DIP	100pcs / each tube